

updated

Freeform Search

Database:	<div style="border: 1px solid black; padding: 2px;"> US Pre-Grant Publication Full-Text Database US Patents Full-Text Database US OCR Full-Text Database EPO Abstracts Database JPO Abstracts Database Derwent World Patents Index IBM Technical Disclosure Bulletins </div>
Term:	<div style="border: 1px solid black; padding: 2px;"> L21 and (flexible circuit board or flexible printed board or flexible substrate) and (thermal sensor or temperature sensor) </div>
Display:	<div style="border: 1px solid black; padding: 2px;">10</div>
Documents in Display Format:	<div style="border: 1px solid black; padding: 2px;">-</div>
Starting with Number	<div style="border: 1px solid black; padding: 2px;">1</div>
Generate: <input type="radio"/> Hit List <input checked="" type="radio"/> Hit Count <input type="radio"/> Side by Side <input type="radio"/> Image	

Search

Clear

Interrupt

 Search History

 DATE: Monday, December 19, 2005 [Printable Copy](#) [Create Case](#)

<u>Set</u> <u>Name</u>	<u>Query</u>	<u>Hit</u> <u>Count</u>	<u>Set</u> <u>Name</u> result set
side by side			
	DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ		
<u>L22</u>	L21 and (flexible circuit board or flexible printed board or flexible substrate) and (thermal sensor or temperature sensor)	14	<u>L22</u>
	DB=PGPB,USPT,USOC,EPAB,JPAB; PLUR=YES; OP=ADJ		
<u>L21</u>	(374/57,185,183,208,144,163,142,179;338/22R,25,28,210,211,283)![CCLS]	9363	<u>L21</u>
	DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ		
<u>L20</u>	L18 and (serpentine or meander or helical or zigzag or hellical)	106	<u>L20</u>
<u>L19</u>	L18 and (serpentine or meander)	60	<u>L19</u>
<u>L18</u>	(flexible circuit board or flexible printed board or flexible substrate) and (thermal sensor or temperature sensor)	675	<u>L18</u>
<u>L17</u>	L16 and (flexible circuit board or flexible substrate)	10	<u>L17</u>
<u>L16</u>	338/28	577	<u>L16</u>
<u>L15</u>	L14 and (flexible circuit board or flexible substrate)	16	<u>L15</u>
<u>L14</u>	L13 AND (TEMPERATURE OR THERMAL\$2)	1582	<u>L14</u>
<u>L13</u>	338/22r	1649	<u>L13</u>
<u>L12</u>	L11 and (temperature or thermal\$2)	191	<u>L12</u>

<u>L11</u>	L10 and (conductor\$1)	195	<u>L11</u>
<u>L10</u>	L9 and (circuit board or printed board or substrate)	406	<u>L10</u>
<u>L9</u>	338/25	888	<u>L9</u>
<u>L8</u>	L7 and (insulator\$3)	89	<u>L8</u>
<u>L7</u>	L6 and (conductor\$1)	119	<u>L7</u>
<u>L6</u>	(circuit board or substrate) and (widen\$2 portions or widen\$2 ends) and (temperature or thermal\$2)	431	<u>L6</u>
<u>L5</u>	(circuit board or substrate) and (widen\$2 portions or widen\$2 ends)	716	<u>L5</u>
<i>DB=USPT; PLUR=YES; OP=ADJ</i>			
<u>L4</u>	5053740.pn.	1	<u>L4</u>
<u>L3</u>	5134248.pn.	1	<u>L3</u>
<u>L2</u>	65134248.pn.	0	<u>L2</u>
<u>L1</u>	6341892.pn.	1	<u>L1</u>

END OF SEARCH HISTORY